



# **GPT65C0YME**

650V ▲ 230mΩ ▲ GaN FET

**GALLIUM NITRIDE GaN FET** ▲ SMD type Normally off device Easy to drive with standard MOSFET driver Small size in 8mm x 8mm ▲ DFN8080 package Moisture Sensitivity Level ▲ MSL 3 Ultra-low Q<sub>RR</sub> and very robust design

| Item (T <sub>C</sub> = 25°C, unless otherwise noted) |                        | Characteristics |
|--|------------------------|-----------------|
| Operating Temperature Range                          | Tı                     | -55°C to +150°C |
| Storage Temperature Range                            | Ts                     | -55°C to +150°C |
| Drain-Source Voltage                                 | V <sub>DSS</sub>       | 650V            |
| Transient Drain-Source Voltage Note 1                | V <sub>TR(DSS)</sub>   | 800V            |
| Drain-Source On-State Resistance Note 2              | R <sub>DS(ON)TYP</sub> | 230mΩ           |
| Typical Recovered Charge Note 3                      | Q <sub>RR</sub>        | 18.6nC          |
| Typical Total Gate Charge                            | $\mathbf{Q}_{G}$       | 16nC            |

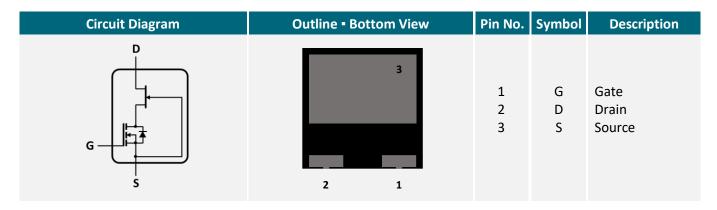
#### **Notes**

- Spike duty cycle DC < 0.01, spike duration time <  $20\mu s$  during off-state mode 1:
- 2:  $V_{GS}$  = 10V,  $I_{DS}$  = 6A
- See diode reverse recovery test circuit and waveform, Fig. 15, and Fig. 16 3:

## **APPLICATIONS**

| Battery  | Power    | LED      | Wireless | AC/DC     | DC/DC     | Class D Audio |
|----------|----------|----------|----------|-----------|-----------|---------------|
| Chargers | Adapters | Lighting | Power    | Converter | Converter | Amplifiers    |
|          | Ū.       | -)       | (((•)))  |           | <u>=/</u> |               |

## **PIN DESCRIPTION**





#### STORAGE AND HANDLING CONDITIONS

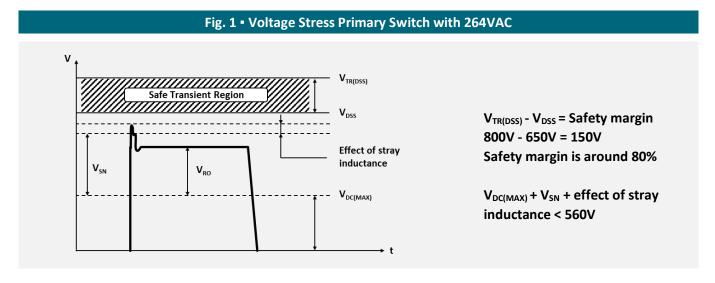
| ESD level   | Floor life | Conditions                      | MSL |
|-------------|------------|---------------------------------|-----|
| HBM class 2 | 168 hours  | T <sub>A</sub> < 30°C, RH < 60% | 3   |

# ABSOLUT MAXIMUM RATINGS ▲ T<sub>C</sub> = 25°C, unless otherwise noted

| Item                                 | Condition                     | Symbol           | Limit       | Unit |
|--------------------------------------|-------------------------------|------------------|-------------|------|
|                                      |                               |                  |             |      |
| Drain-Source Breakdown Voltage       |                               | $V_{\text{DSS}}$ | 650         | V    |
| Transient Drain-Source Voltage Note1 |                               | $V_{(TR)DSS}$    | 800         | V    |
| Gate-Source Voltage                  |                               | $V_{GSS}$        | ±18         | V    |
| Continuous Drain Current             | T <sub>C</sub> = 25°C Note 2  | $I_D$            | 6           | Α    |
| Continuous Drain Current             | T <sub>C</sub> = 100°C Note 2 | $I_D$            | 3.9         | Α    |
| Pulse Drain Current                  | Pulse Width = 10μs            | $I_{DM}$         | 27          | Α    |
| Operating Temperature Range          | Case                          | $T_C$            | -55 to +150 | °C   |
| Operating Temperature Range          | Junction                      | TJ               | -55 to +150 | °C   |
| Storage Temperature Range            |                               | $T_S$            | -55 to +150 | °C   |

#### Note:

- 1: Spike duty cycle DC < 0.01, spike duration time < 20µs during off-state mode
- 2: See application information for increased stability at high current operation, fig. 2

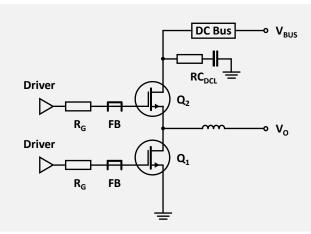


 $\begin{array}{lll} V_{DC(MAX)} & & Maximum input voltage \\ V_{RO} & & Reflected output voltage \\ V_{SN} & & Snubber capacitor voltage \\ V_{DSS} & & Drain-Source breakdown voltage \\ V_{(TR)DSS} & & Transient Drain-source voltage \\ \end{array}$ 



#### APPLICATION INFORMATION

Fig. 2 • Recommended Circuit for Improved Stability at High Current Operation



A ferrite bead (FB) should be connected in series with the gate pin to dampen the resonant circuit of gate-source loop inductance and the input capacitance of the GaN-FET. The ferrite bead should be placed as close as possible to the gate pin to minimize the gate-source loop. (See figure 2). This causes fast switching stability. We recommend an impedance of  $240\Omega$  at 100MHz for the ferrite bead. In addition, a series resistance ( $R_G$ ) of 10 to  $15\Omega$  should be provided.

Furthermore, a DC-link snubber should always be used to eliminate instability of the GaN-FET. In the simplest case, an RC combination is connected in parallel to the DC link bus, which significantly reduces the Q factor of any resonance in the bus. We recommend an MLCC between 4.7 and 10nF and an SMD resistor with  $5.1\Omega$  as well-suited values.

#### THERMAL CHARACTERISTIC RATINGS

| Items   | Тур.              |        |
|---|-------------------|--------|
| Thermal Resistance Junction to Ambient Note 1 | R <sub>thJA</sub> | 53°C/W |
| Thermal Resistance Junction to Case           | R <sub>thJC</sub> | 1°C/W  |

#### Note:

1: Device on one layer epoxy PCB for drain connection (vertical and without air stream cooling, with 6cm² copper and 70μm thickness



# **ELECTRICAL CHARACTERISTICS** ▲ T<sub>C</sub> = 25°C, unless otherwise noted

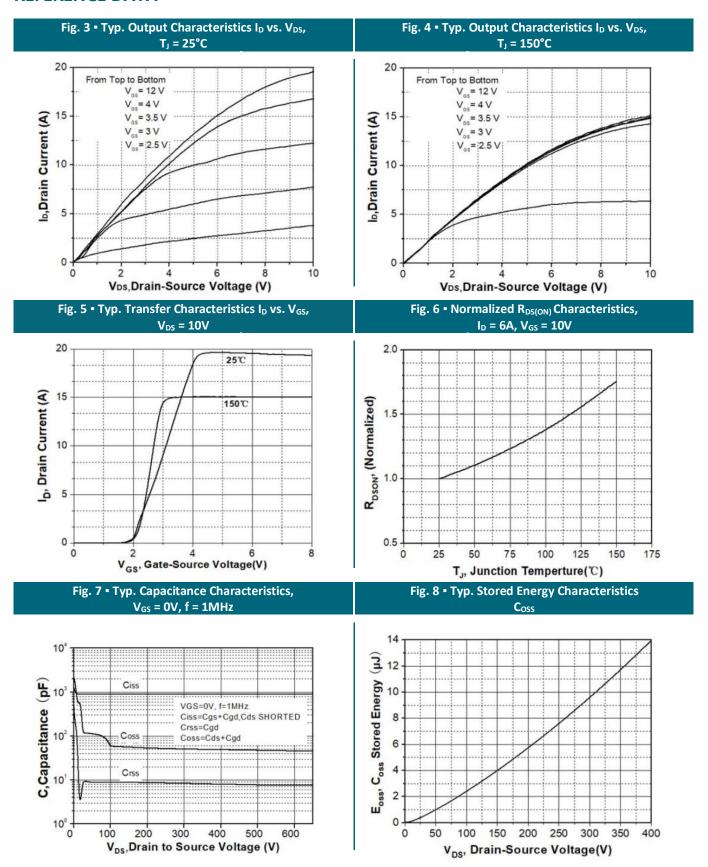
| ltem   | Condition   | Symbol                      | Min. | Тур. | Max. | Unit |
|--|---|-----------------------------|------|------|------|------|
| Static Characteristics                                 |   |                             |      |      |      |      |
| Drain-Source Breakdown Voltage                         | $V_{GS} = 0V$   | $V_{DSS}$                   | 650  |      |      | V    |
| Gate-Source Threshold Voltage                          | $V_{GS} = V_{DS}$ , $I_D = 500 \mu A$                               | $V_{GSth}$                  | 1    | 1.7  | 2.5  | V    |
| Gate-Source Leakage Current                            | $V_{GS} = 18V, V_{DS} = 0V$   | I <sub>GSS</sub>            |      |      | 100  | nA   |
| Gate-Source Leakage Current                            | $V_{GS}$ = -18V, $V_{DS}$ = 0V                                      | I <sub>GSS</sub>            |      |      | -100 | nA   |
| Drain-Source Leakage Current                           | $V_{DS} = 650V$ , $V_{GS} = 0V$                                     | I <sub>DSS</sub>            |      | 5    | 10   | μΑ   |
| Drain-Source Leakage Current                           | $V_{DS} = 650V$ , $V_{GS} = 0V$ , $T_{J} = 150$ °C                  | I <sub>DSS</sub>            |      | 15   |      | μΑ   |
| Drain-Source On-State Resistance                       | $V_{GS} = 10V$ , $I_{DS} = 6A$                                      | R <sub>DS(ON)</sub>         |      | 230  | 300  | mΩ   |
| Drain-Source On-State Resistance                       | $V_{GS} = 10V$ , $I_{DS} = 6A$ , $T_J = 150$ °C                     | R <sub>DS(ON)</sub>         |      | 405  |      | mΩ   |
| ltem   | Condition   | Symbol                      | Min. | Тур. | Max. | Unit |
| Dynamic Characteristics                                |   |                             |      |      |      |      |
| Input Capacitance                                      | $V_{DS} = 400V$ , $V_{GS} = 0V$ , $f = 1MHz$                        | C <sub>ISS</sub>            |      | 400  |      | pF   |
| Output Capacitance                                     | $V_{DS} = 400V$ , $V_{GS} = 0V$ , $f = 1MHz$                        | $C_{OSS}$                   |      | 40   |      | pF   |
| Reverse Transfer Capacitance                           | $V_{DS} = 400V$ , $V_{GS} = 0V$ , $f = 1MHz$                        | $C_{RSS}$                   |      | 8    |      | pF   |
| Effective Output Capacitance,<br>Energy Related Note 1 | $V_{DS} = 0$ to 400V, $V_{GS} = 0$ V                                | $C_{O(ER)}$                 |      | 175  |      | pF   |
| Effective Output Capacitance,<br>Time Related Note 2   | $V_{DS} = 0$ to 400V, $V_{GS} = 0$ V                                | C <sub>O(TR)</sub>          |      | 116  |      | pF   |
| Total Gate Charge                                      | $V_{DS} = 400V$ , $V_{GS} = 0$ to 8V, $I_D = 4A$                    | $Q_{G}$                     |      | 16   |      | nC   |
| Gate-Source Charge                                     | $V_{DS} = 400V$ , $V_{GS} = 0$ to 8V, $I_D = 4A$                    | $Q_{GS}$                    |      | 2.8  |      | nC   |
| Gate-Drain Charge                                      | $V_{DS} = 400V$ , $V_{GS} = 0$ to 8V, $I_D = 4A$                    | $Q_{GD}$                    |      | 4.1  |      | nC   |
| Output Charge  | $V_{DS} = 0 \sim 400V, V_{GS} = 0V$                                 | Qoss                        |      | 46   |      | nC   |
| Turn-On Delay  | $V_{DS}$ = 400V, $V_{GS}$ = 0 to 8V, $I_D$ = 6A, $R_G$ = $30\Omega$ | $t_{D(ON)}$                 |      | 8    |      | ns   |
| Rise Time  | $V_{DS}$ = 400V, $V_{GS}$ = 0 to 8V, $I_D$ = 6A, $R_G$ = $30\Omega$ | $t_R$                       |      | 4    |      | ns   |
| Turn-Off Delay   | $V_{DS}$ = 400V, $V_{GS}$ = 0 to 8V, $I_D$ = 6A, $R_G$ = $30\Omega$ | $t_{\text{D(OFF)}}$         |      | 17   |      | ns   |
| Fall Time  | $V_{DS}$ = 400V, $V_{GS}$ = 0 to 8V, $I_D$ = 6A, $R_G$ = $30\Omega$ | $t_{\scriptscriptstyle{F}}$ |      | 8    |      | ns   |
| ltem   | Condition   | Symbol                      | Min. | Тур. | Max. | Unit |
| Source-Drain Diode                                     |   |                             |      |      |      |      |
| Reverse Current  | $V_{GS} = 0V$   | $I_S$                       |      |      | 6    | Α    |
| Causea Duain Valtaga                                   | $I_S = 3A$ , $V_{GS} = 0V$  | M                           |      | 1.4  |      | V    |
| Source-Drain Voltage                                   | $I_S = 6A$ , $V_{GS} = 0V$  | $V_{SD}$                    |      | 2.4  |      | V    |
| Reverse Recovery Time Note 3                           | $I_S = 4A$ , $V_{DS} = 400V$ , $di/dt = 200A/\mu s$                 | $t_{RR}$                    |      | 11   |      | ns   |
| Recovered Charge Note 4                                | $I_S = 4A$ , $V_{DS} = 400V$ , $di/dt = 200A/\mu s$                 | $Q_{RR}$                    |      | 18.6 |      | nC   |

#### Notes:

- 1: Equivalent capacitance to give same stored energy from 0V to the stated V<sub>DS</sub>
- 2: Equivalent capacitance to give same charging time from 0V to the stated V<sub>DS</sub>
- 3: See diode reverse recovery test circuit and waveform, fig. 15 and fig 16
- 4: See diode reverse recovery test circuit and waveform, fig 15 and fig. 16

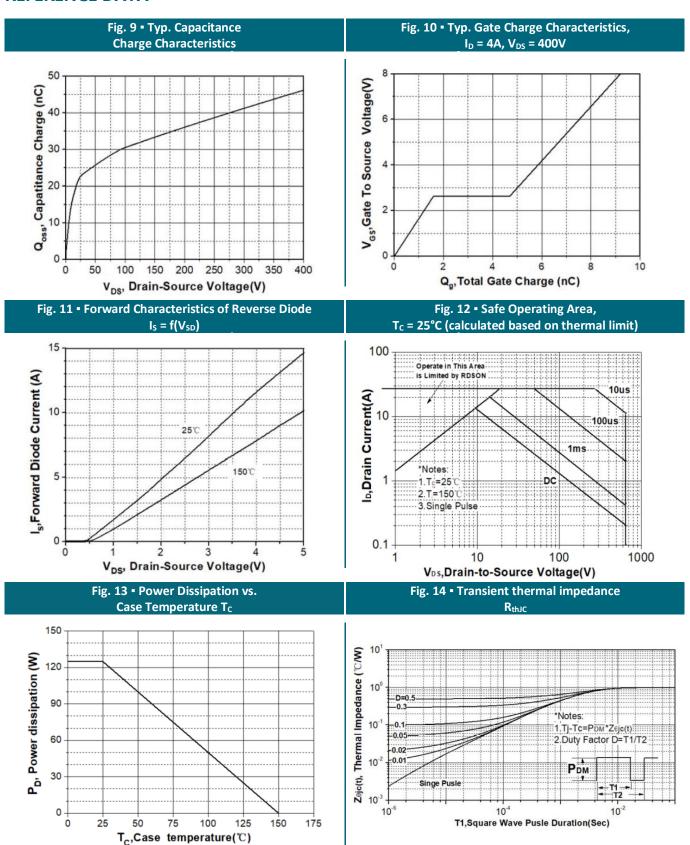


#### REFERENCE DATA





#### REFERENCE DATA





## **TEST CIRCUITS AND WAVEFORMS**

Fig. 15 • Diode reverse recovery test circuit

DUT A V<sub>DS</sub>

Fig. 16 • Diode reverse recovery waveform

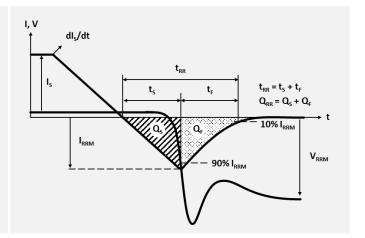


Fig. 17 • Switching time test circuit

SiC Diode V<sub>DS</sub>

Fig. 18 • Switching time waveform

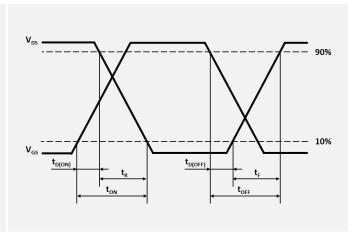


Fig. 19 • Dynamic R<sub>DS(ON)eff</sub> test circuit

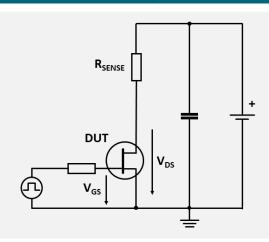
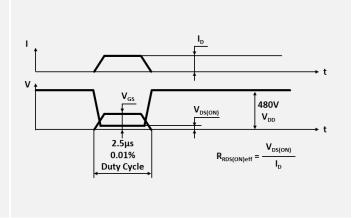
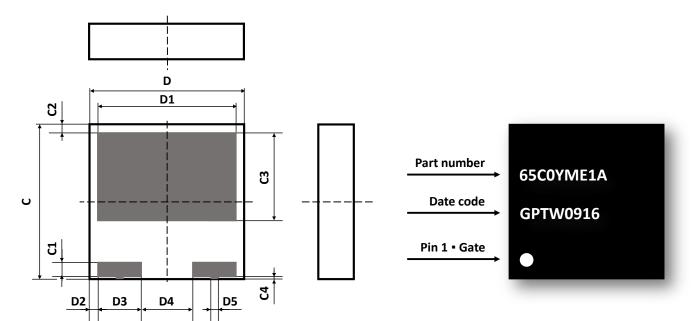


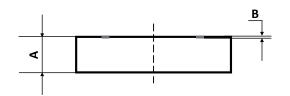
Fig. 20 • Dynamic R<sub>DS(ON)eff</sub> waveform





## PACKAGE OUTLINE AND PART MARKING





09: e.g., week 09 16: e.g., 2022

| Sym | Millimeters   |
|-----|---------------|
| Α   | 1.850 ± 0.025 |
| В   | 0.203 ± 0.008 |
| С   | 8.000 ± 0.050 |
| C1  | 0.800 ± 0.025 |
| C2  | 0.400 ± 0.025 |
| C3  | 4.600 ± 0.050 |
| C4  | 0.100 ± 0.025 |

| Sym | Millimeters   |
|-----|---------------|
| D   | 8.000 ± 0.050 |
| D1  | 7.200 ± 0.050 |
| D2  | 0.400 ± 0.025 |
| D3  | 2.300 ± 0.025 |
| D4  | 2.600 ± 0.025 |
| D5  | 0.400 ± 0.025 |

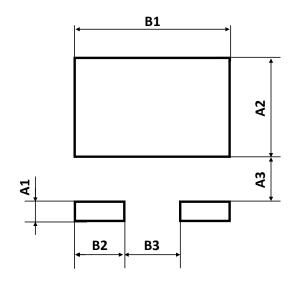
## **DATE CODE**

Example: 0916

| 09                |                        | 16   |      |  |
|-------------------|------------------------|------|------|--|
| Week of the Month |                        | Year |      |  |
|                   |                        | 16   | 2022 |  |
| 01                | <b>1</b> <sup>st</sup> | 17   | 2023 |  |
| 02                | 2 <sup>nd</sup>        | 18   | 2024 |  |
| 03                | 3 <sup>rd</sup>        | 19   | 2025 |  |
| 04                | 4 <sup>th</sup>        | 1A   | 2026 |  |
|                   |                        | 1B   | 2026 |  |
| 52                | 52 <sup>nd</sup>       |      |      |  |
|                   |                        | 1F   | 2031 |  |



## **RECOMMENDED PAD LAYOUT FOR DFN 8080**



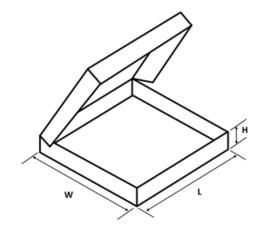
| Sym | Millimeters |
|-----|-------------|
| A1  | 1.000       |
| A2  | 4.750       |
| A3  | 2.000       |
| B1  | 7.350       |
| B2  | 2.450       |
| В3  | 2.450       |

## **ORDERING INFORMATION**

| Part Number | Package | Packing       | Quantity | Reel Diameter |
|-------------|---------|---------------|----------|---------------|
| GPT65C0YME  | DFN8080 | Tape and Reel | 2500pcs  | 330mm (13")   |

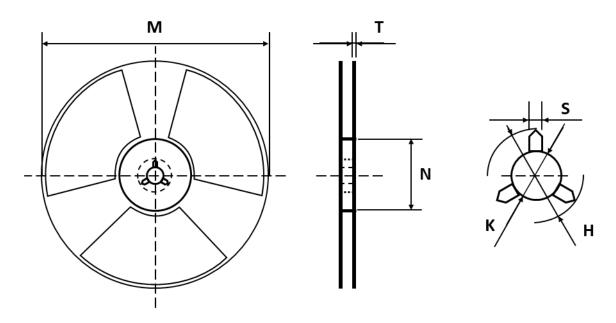
# **REEL BOX DIMENSION** ▲ All dimensions in mm

| Outside Dimensions |     |  |  |  |
|--------------------|-----|--|--|--|
| Ø 330mm reel       |     |  |  |  |
| W 350              |     |  |  |  |
| L                  | 350 |  |  |  |
| Н                  | 80  |  |  |  |



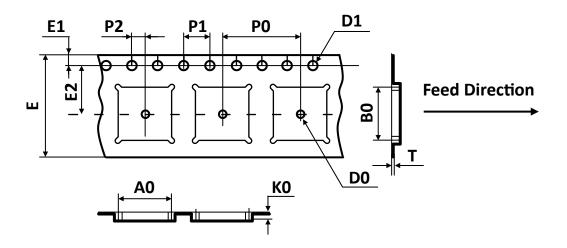


## **REEL DIMENSIONS** ▲ All dimensions in mm



| Tape Size | Reel Size | M       | N       | Т    | Н              | К     | S     |
|-----------|-----------|---------|---------|------|----------------|-------|-------|
|           |           | Ø330.00 | Ø102.00 | 2.00 | 13.00          | 10.50 | 2.00  |
| 24mm      | Ø330      | ±0.20   | ±0.10   | ±2.0 | +0.50<br>-0.20 | ±0.25 | ±0.25 |

# **TAPE DIMENSIONS** ▲ All dimensions in mm

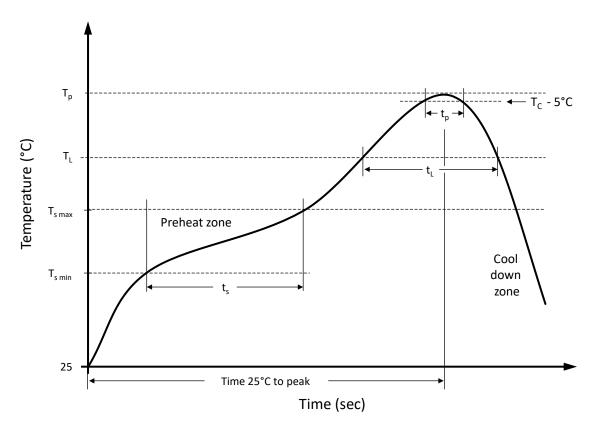


| Package  | Α0    | В0    | КО    | D0    | D1    | E     | E1    | E2    | P0    | P1    | P2    | Т     |
|----------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
| DFN8080  | 8.30  | 8.30  | 1.15  | 1.50  | 1.50  | 24.00 | 1.75  | 7.50  | 12.00 | 4.00  | 2.00  | 0.30  |
| DEINOUOU | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.30 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.05 |

Note: All dimensions meet EIA-481-D requirements.



## **RECOMMENDED REFLOW SOLDERING PROFILE**



# **Recommended reflow soldering conditions** ▲ **Refer to JEDEC J-STD-020E**

| Profile Features  |                    | Sn-Pb Eutetic Assembly | Pb-Free Assembly |  |
|---|--------------------|------------------------|------------------|--|
| Preheat temperature min.  | $T_{s  min}$       | 100 °C                 | 150 °C           |  |
| Preheat temperature max.  | T <sub>s max</sub> | 150 °C                 | 200 °C           |  |
| Preheat time t <sub>s</sub> from T <sub>s min</sub> to T <sub>s max</sub> | $t_s$              | 120 seconds            | 120 seconds      |  |
| Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )                          |                    | max. 3 °C/second       | max. 3 °C/second |  |
| Liquidous temperature   | $T_L$              | 183 °C                 | 217 °C           |  |
| Time t <sub>L</sub> maintained above T <sub>L</sub>                       | t <sub>L</sub>     | 150 seconds max.       | 150 seconds max. |  |
| Peak package body temperature   | $T_p$              | 235°C                  | 260°C            |  |
| Timeframe of within 5°C below and up to max actual peak body temperature  | t <sub>p</sub>     | 20 seconds max.        | 30 seconds max.  |  |
| Ramp-down rate (T <sub>L</sub> to T <sub>p</sub> )                        |                    | max. 6 °C/second       | max. 6 °C/second |  |
| Time 25°C to peak temperature   |                    | max. 6 minutes         | max. 8 minutes   |  |



#### **REVISION TABLE**

| Revision | Date       | Status          | Notes  |
|----------|------------|-----------------|--|
| 001      | 01/01/2022 | Initial release | Initial publication                                  |
| 002      | 30/03/2022 | Second release  | C <sub>ISS</sub> and C <sub>OSS</sub> values updated |
| 003      | 18/05/2022 | Third release   | Part marking   |
|          |            |                 |  |
|          |            |                 |  |
|          |            |                 |  |

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IPS70R2K0CEAKMA1 DMN3404LQ-7 NTE6400 2SK2614(TE16L1,Q) DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W
FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2969
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DMN1006UCA6-7 DMN16M9UCA6-7